

DIO4481X

USB Type-C Analog Audio Switch with Protection Function

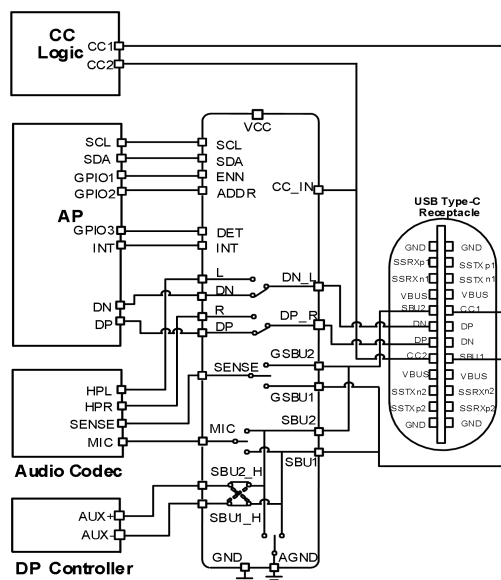
Features

- Power supply voltage range: 2.7 V to 5.5 V
- Version information:
 - DIO4481/DIO4481L: Default: DP_R~DP; DN_L~DN; turn on
 - DIO4481B/DIO4481LB: Default: DP_R~DP; DN_L~DN; SBU1~SBU1_H; SBU2~SBU2_H turn on
- USB2.0 high-speed switch:
 - -3 dB bandwidth: 970 MHz
 - $R_{ON} = 4.3 \Omega$ (Typ)
- Audio switch
 - Negative rail capability: -3.6 V to 3.6 V
 - THD + N = -110 dB, 1 V_{RMS},
 - f = 20 Hz to 20 kHz, 32 Ω load
 - -3 dB bandwidth: 830 MHz
 - $R_{ON} = 1.0 \Omega$ (Typ)
- High voltage protection
 - +20 V DC tolerance on USB Type-C pins
 - +25 V surge capable on USB Type-C pins
 - -20 V surge capable on USB Type-C pins
 - ± 8 kV HBM ESD
- Over voltage protection:
 - DP_R, DN_L $V_{TH} = 4.8$ V (Typ)
 - SBU1/SBU2/GSBU1/GSBU2 $V_{TH} = 4.5$ V (Typ)
- Support OMTP, CTIA, and 3-pole audio jack pinouts
- 25-ball WLCSP package (2.24 mm × 2.28 mm)

Descriptions

The DIO4481/DIO4481B/DIO4481L/DIO4481LB are high-performance USB Type-C analog switches that support analog audio headsets and can be used in portable multimedia devices. They can detect OMTP, CTIA, or 3-pole headsets and configure pinouts automatically. The DIO4481/B/L/LB shares common Type-C pins to pass USB 2.0 signals, analog audio signals, the sideband use wires and analog microphone signals. The DIO4481/B/L/LB also supports high voltages and surges on SBUx pins and USB pins on the USB Type-C receptacle side.

Block Diagram



Applications

- Mobile phones
- Tablets
- Notebook PCs
- Media players

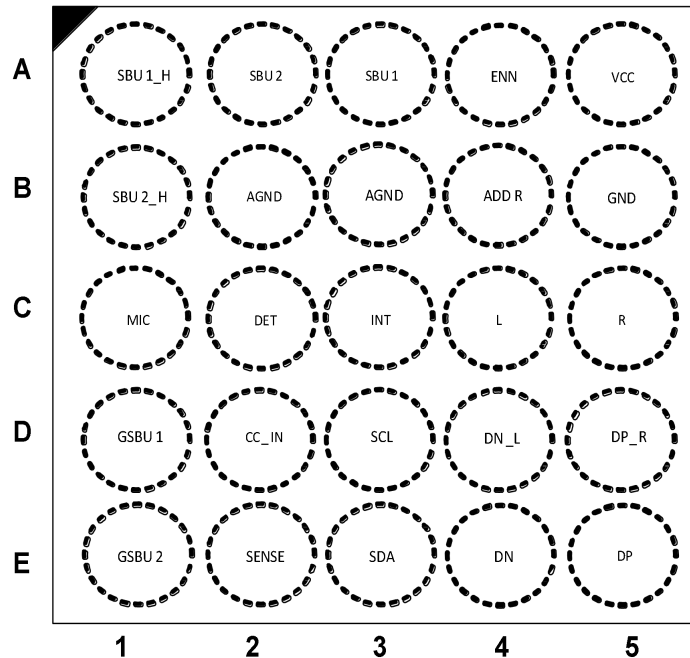


DIO4481X

Ordering Information

Ordering Part No.	Top Marking	MSL	RoHS	T _A	Package	
DIO4481WL25	D4HA	1	Green	-40 to 85°C	WLCSP-25	Tape & Reel, 3000
DIO4481LWL25	DH1L	1	Green	-40 to 85°C	WLCSP-25	Tape & Reel, 3000
DIO4481BWL25	DH1B	1	Green	-40 to 85°C	WLCSP-25	Tape & Reel, 3000
DIO4481LBWL25	D1LB	1	Green	-40 to 85°C	WLCSP-25	Tape & Reel, 3000

Pin Assignment



WLCSP-25

Figure 1. Top view

Pin Descriptions

Pin	Name	Description
A5	VCC	Power supply (2.7 V to 5.5 V)
B5	GND	Chip ground
D5	DP_R	USB/Audio common pin
D4	DN_L	USB/Audio common pin
E5	DP	USB data (differential +)
E4	DN	USB data (differential –)
C5	R	Audio – right channel
C4	L	Audio – left channel
A3	SBU1	Sideband use wire 1
A2	SBU2	Sideband use wire 2
C1	MIC	Microphone signal
B2	AGND	Audio signal ground
B3	AGND	Audio signal ground
E2	SENSE	Audio ground reference output
C3	INT	I ² C Interrupt output, active low (open drain)
D2	CC_IN	Audio accessory attachment detection input
D1	GSBU1	Audio sense path 1 to headset jack GND
E1	GSBU2	Audio sense path 2 to headset jack GND
C2	DET	Push–pull output. When CC_IN > 1.5 V, DET is low and CC_IN < 1.2 V, DET is high
D3	SCL	I ² C clock
E3	SDA	I ² C data
B1	SBU2_H	Host side sideband use wire 2
A1	SBU1_H	Host side sideband use wire 1
A4	ENN	Chip enable, active low, internal pull–down by 470 kΩ
B4	ADDR	I ² C slave address pin

Absolute Maximum Ratings

Stresses beyond those listed under the Absolute Maximum Rating table may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Symbol	Parameter		Rating	Unit
V_{CC}	Supply voltage from VCC		-0.5 to 6.5	V
V_{CC_IN}	V_{CC_IN} to GND		-0.5 to 20	V
V_{SW_C}	V_{DP_R} to GND, V_{DN_L} to GND		-3.5 to 20	V
V_{SW_USB}	V_{DP} to GND, V_{DN} to GND		-0.5 to 6.5	V
V_{SW_Audio}	V_L to GND, V_R to GND		-3.6 to 6.5	V
$V_{V_SBUx/GSBUx}$	V_{SBU1} to GND, V_{SBU2} to GND, V_{GSBU1} to GND, V_{GSBU2} to GND		-0.5 to 20	V
V_{VSBUx_H}	V_{SBU1_H} to GND, V_{SBU2_H} to GND		-0.5 to 6.5	V
$V_{I/O}$	SENSE, MIC, DET, INT to GND		-0.5 to 6.5	V
V_{CNTRL}	Control input voltage	SDA, SCL, ENN, ADDR	-0.5 to 6.5	V
I_{SW_Audio}	Switch I/O current, audio path		-250 to 250	mA
I_{SW_USB}	Switch I/O current, USB path		100	mA
I_{SW_MIC}	Switch I/O current, MIC to SBU1 or SBU2		50	mA
I_{SW_SBUx}	Switch I/O current, SBUx to SBUx_H		50	mA
I_{SW_SENSE}	Switch I/O current, SENSE to GSBU1 or GSBU2		100	mA
I_{SW_AGND}	Switch I/O current, AGND to SBU1 or SBU2		500	mA
I_{IK}	DC input diode current		-50	mA
ESD	HBM	Human body model, ANSI/ESDA/JEDEC JS-001	Connector side and power pins: V_{CC} , SBU1, SBU2, DP_R, DN_L, GSBU1, GSBU2, CC_IN	± 8 kV
			Host side pins: the rest pins	± 5 kV
	CDM	Charged device mode, JEDEC: JESD22-C101		± 2 kV
T_{STG}	Storage temperature		-65 to 150	°C

Recommend Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. DIOO does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min	Typ	Max	Unit
Power					
V_{CC}	Supply voltage	2.7		5.5	V
USB switch					
V_{SW_USB}	V_{DP} to GND, V_{DN} to GND, V_{DP_R} to GND, V_{DN_L} to GND	0		3.6	V
AUDIO switch					
V_{SW_Audio}	V_{DP_R} to GND, V_{DN_L} to GND, V_L to GND, V_R to GND	-3.6		3.6	V
MIC switch					
V_{SBU_MIC}	V_{SBU1} to GND, V_{SBU2} to GND, V_{MIC} to GND	0		3.6	V
SENSE switch					
V_{GHSBU_SEN}	V_{GHSBU1} to GND, V_{GHSBU2} to GND, V_{SENSE} to GND	0		3.6	V
SBU to SBUX_H switch					
V_{GHSBU}	V_{SBU1} to GND, V_{SBU2} to GND, V_{SBU1_H} to GND, V_{SBU2_H} to GND	0		3.6	V
CC_IN pin					
V_{CC_IN}	V_{CC_IN} to GND	0		5.5	V
Control voltage (ADDR/ENN/SDA/SCL)					
V_{IH}	DIO4481WL25	Input voltage high	1.3	V_{CC}	V
V_{IL}	DIO4481BWL25	Input voltage low		0.5	V
V_{IH}	DIO4481LWL25	Input voltage high	0.825	V_{CC}	V
V_{IL}	DIO4481LBWL25	Input voltage low		0.35	V
Operating temperature					
T_A	Ambient operating temperature	-40	25	85	°C

DC Electrical Characteristics

$V_{CC} = 2.7\text{ V to }5.5\text{ V}$, $V_{CC}(\text{Typ.}) = 3.3\text{ V}$, $T_A = -40^\circ\text{C to }85^\circ\text{C}$, and $T_A(\text{Typ.}) = 25^\circ\text{C}$, unless otherwise specified.

Symbol	Parameter	Conditions	Power	Min	Typ	Max	Unit
I _{CC}	Supply current	USB switches on, SBU _x to SBU _x _H switches on	V _{CC} = 4.2 V		70		μA
		Audio switches on, MIC switch on and Audio GND switch on			70		μA
I _{CCZ}	Quiescent current	ENN = L, 04H'b7 = 0			3		μA
USB/AUDIO common pins: DP_R, DN_L							
I _{OZ}	Off leakage current of DP_R and DN_L	DN_L, DP_R = -3 V to 3.6 V	V _{CC} = 2.7 V to 5.5 V	-3		3	μA
I _{OFF}	Power-off leakage current of DP_R and DN_L	DN_L, DP_R = 0 V to 3.6 V	Power off	-3		3	μA
V _{OV_TRIP}	Input OVP lockout	Rising edge	V _{CC} = 2.7 V to 5.5 V	4.6	4.8	5	V
V _{OV_HYS}	Input OVP hysteresis				0.3		V
AUDIO switch							
I _{ON}	On leakage current of audio switch	DN_L, DP_R = -3 V to 3 V, DP, DN, R, L = Float	V _{CC} = 2.7 V to 5.5 V	-3		3	μA
I _{OFF}	Power-off leakage current of L and R	L, R = 0 V to 3 V; DP_R, DN_L = Float	Power off	-1		1	μA
R _{ON}	Switch on resistance	I _{SW} = 100 mA, V _{SW} = -3 V to 3 V	V _{CC} = 2.7 V to 5.5 V		1		Ω
R _{SHUNT}	Pull-down resistor on R/L pin when audio switch is off	L= R = 3 V		6	10	14	kΩ
USB switch							
I _{ON}	On leakage current of USB switch	DN_L, DP_R = 0V to 3.6 V, DP, DN, R, L = float	V _{CC} = 2.7 V to 5.5 V	-3		3	μA
I _{OZ}	Off leakage current of DP and DN	DN, DP = 0 V to 3.6 V	V _{CC} = 2.7 V to 5.5 V	-3		3	μA
I _{OFF}	Power-off leakage current of DP and DN	DN, DP = 0 V to 3.6 V	Power off	-3		3	μA
R _{ON_USB}	USB switch on resistance	I _{SW} = 8 mA, V _{SW} = 0.4 V	V _{CC} = 2.7 V to 5.5 V		4.3		Ω
SENSE switch							
I _{ON}	Sense path leakage current	GSBU _x = 0 V to 1 V, SENSE is floating	V _{CC} = 2.7 V to 5.5 V	-2		2	μA
R _{ON}	SENSE switch on resistance	I _{OUT} = 100 mA, V _{SW} =1.0 V	V _{CC} = 2.7 V to 5.5 V		270		mΩ

I _{OZ}	Off leakage current of SENSE	SENSE = 0 V to 1.0 V	V _{CC} = 2.7 V to 5.5 V	-2		2	μA
	Off leakage current of GSBUX	GSBUX = 1 V to 3.6 V		-3		3	
I _{OFF}	Power-off leakage current of SENSE	SENSE = 0 V to 1.0 V	V _{CC} = 2.7 V to 5.5 V	-2		2	μA
	Power-off leakage current of GSBUX	GSBUX = 0 V to 3.6 V		-3		3	
V _{OV_TRIP}	Input OVP lockout on GSBUX	Rising edge	V _{CC} = 2.7 V to 5.5 V	4.3	4.5	4.7	V
V _{OV_HYS}	Input OVP hysteresis of GSBUX				0.3		V
SBUX pins							
I _{OZ}	Off leakage current of SBUX	SBUX = 0 V to 3.6 V	V _{CC} = 2.7 V to 5.5 V	-3		3	μA
I _{OFF}	Power-off leakage Current port SBUX	SBUX = 0 V to 3.6 V	Power off	-2		10	μA
V _{OV_TRIP}	Input OVP lockout	Rising edge	V _{CC} = 2.7 V to 5.5 V	4.3	4.5	4.7	V
V _{OV_HYS}	Input OVP hysteresis				0.3		V
MIC switch							
I _{ON}	On leakage current of MIC switch	SBUX = 0 V to 3.6 V, MIC is floating	V _{CC} = 2.7 V to 5.5 V	-3		3	μA
I _{OZ}	Off leakage current of MIC	MIC = 0 V to 3.6 V		-1		1	μA
I _{OFF}	Power-off leakage current of MIC	MIC = 0 V to 3.6 V	Power off	-1		1	μA
R _{ON}	MIC switch on resistance	V _{SW} = 3.6 V, I _{sw} = 30 mA	V _{CC} = 2.7 V to 5.5 V		3.3		Ω
SBUX_H switch							
I _{ON}	On leakage current of SBUX_H switch	SBUX = 0 V to 3.6 V, SBUX_H is floating	V _{CC} = 2.7 V to 5.5 V	-3		3	μA
I _{OZ}	Off leakage of SBUX_H	SBUX_H = 0 V to 3.6 V		-1		1	μA
I _{OFF}	Power-off leakage current of SBUX_H	SBUX_H = 0 V to 3.6 V	Power off	-1		1	μA
R _{ON}	SBUX_H switch on resistance	V _{SW} = 0 V to 3.6 V, I _{sw} = 30 mA	V _{CC} = 2.7 V to 5.5 V		2.8		Ω
AUDIO ground switch: pin: AGND to SBUX							
R _{ON}	AGND switch on resistance	I _{SOURCE} = 100 mA on SBUX	V _{CC} = 2.7 V to 5.5 V		66		mΩ
CC_IN pin							
V _{TH_L}	Input low threshold		V _{CC} = 2.7 V to 5.5 V		1.2		V
V _{TH_H}	Input high threshold				1.5		V
I _{IN}	Input leakage of CC_IN	CC_IN = 0 V to 5.5 V				1	μA

INT, DET pins							
V _{OH}	Output high for DET	Io = −2 mA	V _{CC} = 2.7 V to 5.5 V	1.5	1.8	2	V
V _{OL}	Output low for DET and INT	Io = 2 mA				0.4	V
ADDR pin							
V _{IH}	DIO4481WL25	Input voltage high	V _{CC} = 2.7 V to 5.5 V	1.3			V
V _{IL}	DIO4481BWL25	Input voltage low				0.5	V
V _{IH}	DIO4481LWL25	Input voltage high		0.825			V
V _{IL}	DIO4481LBWL25	Input voltage low				0.35	V
I _{IN}	Control input leakage	ADDR = 0 V to V _{CC}		-1		1	μA
ENN pin							
V _{IH}	DIO4481WL25	Input voltage high	V _{CC} = 2.7 V to 5.5 V	1.3			V
V _{IL}	DIO4481BWL25	Input voltage low				0.5	V
V _{IH}	DIO4481LWL25	Input voltage high		0.825			V
V _{IL}	DIO4481LBWL25	Input voltage low				0.35	V
R _{PD}	Internal pull down resistor				470		kΩ
SDS, SCL pins							
V _{ILi2C}	DIO4481WL25	Low-level input voltage	V _{CC} = 2.7 V to 5.5 V			0.5	V
V _{IHi2C}	DIO4481BWL25	High-level input voltage		1.3			V
V _{ILi2C}	DIO4481LWL25	Low-level input voltage				0.35	V
V _{IHi2C}	DIO4481LBWL25	High-level input voltage		0.825			V
I _{i2C}	Input current of SDA and SCL pins	SCL/SDA = 0 V to 3.6 V		-2		2	μA
V _{OLSDA}	Low-level output voltage	I _{OLSDA} = 2 mA				0.3	V
I _{OLSDA}	Low-level output current	V _{OLSDA} = 0.2 V		10			mA

Note:

(1) Specifications subject to change without notice.

AC Electrical Characteristics

$V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $V_{CC} \text{ (Typ.)} = 3.3 \text{ V}$, $T_A = -40^\circ\text{C to } 85^\circ\text{C}$, and $T_A \text{ (Typ.)} = 25^\circ\text{C}$, unless otherwise specified.

Symbol	Parameter	Conditions	Power	Min	Typ	Max	Unit
AUDIO switch							
t _{delay}	Audio switch turn-on delay time	DP_R = DN_L = 1 V, R _L = 32 Ω	V _{CC} = 3.3 V		40		μs
t _{rise}	Audio switch turn-on rising time ⁽¹⁾	DP_R = DN_L = 1 V, R _L = 32 Ω			75		μs
t _{OFF}	Audio switch turn-off time	DP_R = DN_L = 1 V, R _L = 32 Ω			7		μs
X _{TALK}	Cross talk (adjacent)	f = 1 kHz, R _L = 50 Ω, V _{SW} = 1 V _{RMS}			-90		dB
BW	-3 dB bandwidth	R _L = 50 Ω			830		MHz
OIRR	Off isolation	f = 1 kHz, R _L = 50 Ω, C _L = 0 pF, V _{SW} = 1 V _{RMS}			-95		dB
THD+N	Total harmonic distortion + noise performance with A-weighting filter	R _L = 600 Ω, f = 20 Hz ~ 20 kHz, V _{SW} = 2 V _{RMS}			-110		dB
		R _L = 32 Ω, f = 20 Hz ~ 20 kHz, V _{SW} = 1 V _{RMS}			-110		dB
		R _L = 16 Ω, f = 20 Hz ~ 20 kHz, V _{SW} = 0.5 V _{RMS}		-108		dB	
USB switch							
t _{ON}	USB switch turn-on time	DP_R = DN_L = 1.5 V, R _L = 50 Ω	V _{CC} = 3.3 V		40		μs
t _{OFF}	USB switch turn-off time	DP_R = DN_L = 1.5 V, R _L = 50 Ω			6		μs
BW	-3 dB bandwidth	R _L = 50 Ω			970		MHz
OIRR	Off-isolation between DP, DN and common node pins	f = 1 kHz, R _L = 50 Ω, C _L = 0 pF, V _{SW} = 1 V _{RMS}			-100		dB
t _{OVP}	DP_R and DN_L pins OVP response time	Vsw = 3.5 V to 5.5 V			0.4		μs
MIC/AUDIO ground switch							
t _{delay_MIC}	MIC switch turn-on delay time	SBUx = 1 V, R _L = 50 Ω	V _{CC} = 3.3 V		75		μs
t _{rise_MIC}	MIC switch turn-on rising time ⁽¹⁾				120		
t _{delay_AGND}	AGND switch turn-on time	SBUx pulled up to 0.5 V by 16 Ω, AGND connect to GND			1		ms
t _{rise_AGND}	AGND switch turn-on rising time ⁽¹⁾				1.5		
t _{OFF_MIC}	MIC switch turn-off time			SBUx = 2.5 V, R _L = 50 Ω		6	

t _{OFF_Audio} GND	AGND switch turn-off time	SBUx: Isource = 10 mA, clamp to 2.5 V			65		μs
BW	-3dB bandwidth	R _L = 50 Ω			60		MHz
SBUx_H switch							
t _{ON}	SBUx_H switch turn-on time	SBUx = 2.5 V, R _L = 50 Ω	V _{CC} = 3.3 V		65		μs
t _{OFF}	SBUx_H switch turn-off time				150		ns
BW	-3dB Bandwidth	R _L = 50 Ω			60		MHz
t _{OVP}	SBUx pins OVP response time	Vsw = 3.5 V to 5.5 V			0.4		μs
SENSE switch							
t _{delay}	Sense switch turn-on delay time	GSBUx =1 V, R _L = 50 Ω	V _{CC} = 3.3 V		280		μs
t _{rise}	Sense switch turn-on rising time ⁽¹⁾				500		μs
t _{OFF}	Sense switch turn-off time				6.5		μs
t _{OVP}	GSBUx pins OVP response time	V _{SW} = 3.5 V to 5.5 V			0.4		μs
BW	-3dB Bandwidth	R _L = 50 Ω			150		MHz
DET delay							
t _{DELAY_DET}	DET response delay	Transition from 0 to 1.8 V	V _{CC} = 3.3 V		0.9		μs
		Transition from 1.8 to 0 V			2		

Note:

- (1) Turn-on timing can be controlled by I²C register.
 (2) Specifications subject to change without notice.

I²C Specification

$V_{CC} = 2.7\text{ V to } 5.5\text{ V}$, $V_{CC} (\text{Typ.}) = 3.3\text{ V}$, $T_A = -40^\circ\text{C to } 85^\circ\text{C}$, and $T_A (\text{Typ.}) = 25^\circ\text{C}$, unless otherwise specified.

Symbol	Parameter	Min	Typ	Max	Unit
f_{SCL}	I ² C_SCL clock frequency			400	kHz
$t_{HD; STA}$	Hold time (repeated) START condition	0.6			μs
t_{LOW}	Low period of I ² C_SCL Clock	1.3			μs
t_{HIGH}	High period of I ² C_SCL Clock	0.6			μs
$t_{SU; STA}$	Set-up time for repeated START condition	0.6			μs
$t_{HD; DAT}$	Data hold time ⁽¹⁾	0		0.9	μs
$t_{SU; DAT}$	Data set-up time ⁽²⁾	100			ns
t_r	Rise time of I ² C_SDA and I ² C_SCL signals ⁽²⁾	$20 + 0.1 C_b$		300	ns
t_f	Fall time of I ² C_SDA and I ² C_SCL Signals ⁽²⁾	$20 + 0.1 C_b$		300	ns
$t_{SU; STO}$	Set-up time for STOP condition	0.6			μs
t_{BUF}	Bus-free time between STOP and START conditions	1.3			μs
t_{SP}	Pulse width of spikes that must be suppressed by the input filter	0		50	ns

Note:

(1) Guaranteed by characterization. Not production tested.

(2) A fast-mode I²C-bus device can be used in a standard-mode I²C-bus system, but the requirement $t_{SU; DAT} \geq \pm 250\text{ ns}$ must be met. This is automatically the case if the device does not stretch the LOW period of the I²C_SCL signal. If such a device does stretch the LOW period of the I²C_SCL signal, it must output the next data bit to the I²C_SDA line $t_{r_max} + t_{SU; DAT} = 1000 + 250 = 1250\text{ ns}$ (according to the standard-mode I²C bus specification) before the I²C_SCL line is released.

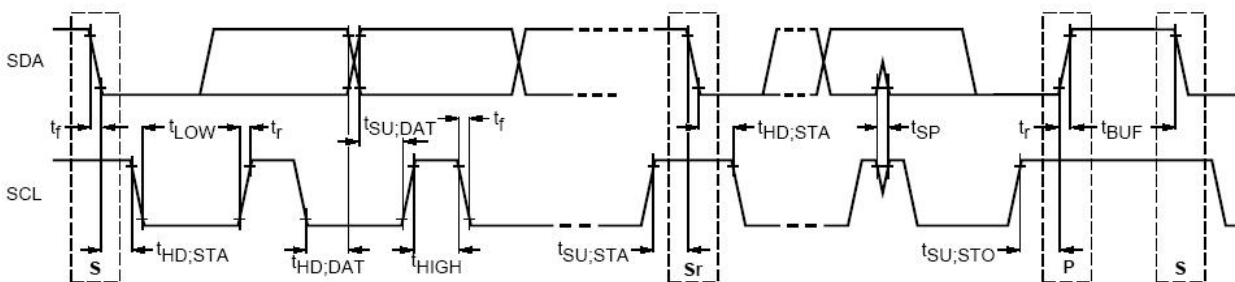


Figure 2. Definition of timing for full-speed mode devices on the I²C bus

Capacitance

$V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $V_{CC} \text{ (Typ.)} = 3.3 \text{ V}$, $T_A = -40^\circ\text{C to } 85^\circ\text{C}$, and $T_A \text{ (Typ.)} = 25^\circ\text{C}$, unless otherwise specified.

Symbol	Parameter	Conditions		Power	Min	Typ	Max	Unit
C _{CON_USB/Audio}	On capacitance (common port)	f = 1 MHz, 100 mV _{PK-PK} , 100 mV DC bias		V _{CC} = 3.3 V		8		pF
C _{COFF_USB/Audio}	On capacitance (common port)	f = 1 MHz, 100 mV _{PK-PK} , 100 mV DC bias				6.5		pF
C _{COFF_USB}	Off capacitance (Non-common ports)	f = 1 MHz, 100 mV _{PK-PK} , 100 mV DC bias				2.6		pF
C _{CON_SENSE_SW}	On capacitance (common ports)	f = 1 MHz, 100mV _{PK-PK} , 100 mV DC bias				55		pF
C _{COFF_SENSE_SW}	Off capacitance (common ports)	f = 1 MHz, 100 mV _{PK-PK} , 100 mV DC bias				88		pF
C _{CON_MIC_SW}	On capacitance (common ports)	f = 1 MHz, 100 mV _{PK-PK} , 100 mV DC bias				170		pF
C _{COFF_MIC_SW}	Off capacitance (common ports)	f = 1 MHz, 100 mV _{PK-PK} , 100 mV DC bias				10		pF
C _{CON_AGND_SW}	On capacitance (common port)	f = 1 MHz, 100 mV _{PK-PK} , 100 mV DC bias				125		pF
C _{CON_SBUx_H_SW}	On capacitance (common port)	f = 1 MHz, 100 mV _{PK-PK} , 100 mV DC bias				160		pF
C _{CNTRL}	Control input pin capacitance	f = 1 MHz, 100 mV _{PP} , 100 mV DC bias	ENN			3		pF

Register Maps

ADDR	Register Name	Type	Reset Value	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
00H	Device ID	R	0XF3	1	1	1	1	0	0	0	1
01H	OVP interrupt mask	R/W	0x00	Reserved	Mask OVP interrupt	Mask OVP /DP_R	Mask OVP /DN_L	Mask OVP /SBU1	Mask OVP /SBU2	Mask OVP /GSBU1	Mask OVP /GSBU2
02H	OVP interrupt flag	R	0x00	Reserved	Reserved	OVP/DP_R	OVP/DN_L	OVP/SBU1	OVP/SBU2	OVP/GSBU1	OVP/GSBU2
03H	OVP status	R	0x00	Reserved	Reserved	OVP/DP_R	OVP/DN_L	OVP/SBU1	OVP/SBU2	OVP/GSBU1	OVP/GSBU2
04H	Switch settings enable	R/W	4481/L: 0x98	Device control	SBU1_H to SBUx	SBU2_H to SBUx	DN_L to DN or L	DP_R to DP or R	Sense to GSBUx	MIC to SBUx	Audio ground to SBUx
			4481B/L B:0xF8								
05H	Switch select	R/W	0x18	Reserved	SBU1_H to SBUx	SBU2_H to SBUx	DN_L to DN or L	DP_R to DP or R	Sense to GSBUx	MIC to SBUx	Audio Ground to SBUx
06H	Switch Status0	R	0x05	Reserved		Sense switch status		DP_R switch status		DN_L switch status	
07H	Switch Status1	R	4481/L: 0x00	Reserved		SBU2 switch status				SBU1 switch status	
			4481B/L B:0x23								
08H	Audio switch left channel turn-on control	R/W	0x01	Audio switch left channel slow control [7:0]							
09H	Audio switch right channel turn-on control	R/W	0x01	Audio switch right channel slow control [7:0]							
0AH	MIC switch turn on control	R/W	0x01	MIC switch slow control [7:0]							
0BH	Sense switch turn-on control	R/W	0x01	Sense switch slow control [7:0]							
0CH	Audio ground switch turn-on control	R/W	0x01	Audio ground switch slow control [7:0]							
0DH	Timing delay between R switch enable and switch on order	R/W	0x00	Timing delay between R switch enable and switch on order control [7:0]							
0EH	Timing delay between MIC switch enable	R/W	0x00	Timing delay between MIC switch enable and switch on order control [7:0]							

	and switch on order										
0FH	Timing delay between Sense switch enable and switch on order	R/W	0x00	Timing delay between Sense switch enable and switch on order control [7:0]							
10H	Timing delay between Audio ground switch enable and switch on order	R/W	0x00	Timing delay between Audio ground switch enable and switch on order control [7:0]							
11H	Audio accessory status	R	0x02	Reserved						CC_IN	DET
12H	Function enable	R/W	0x00	Reserved	DET I/O Control	Reserved	GPIO control enable	Slow turn on control enable	MIC auto break out control enable	Reserved	Audio jack detection and configuration enable
13H	RES detection pin setting	R/W	0x00	Reserved					Resistance detection pin select [2:0]		
14H	RES detection value	R	0x00	Reserved		Moisture occur pin indicate					
15H	RES detection interrupt threshold	R/W	0x02	Reserved					Resistance detection threshold[2:0]		
16H	RES detection interval	R/W	0x04	Reserved				Res detection time[3:2]		Res detection interval [1:0]	
17H	Audio jack status	R	0x01	Reserved				4 pole, SBU2 to MIC	4 pole, SBU1 to MIC	3 pole	No audio
18H	RES detection/ audio Jack detection interrupt flag	R	0x00	Reserved					Audio jack detection done	Low resistance occurred	Low resistance detection
19H	RES/Audio jack detection interrupt mask	R/W	0x00	Reserved					Audio detection done mask	Low resistance occurred	Low resistance detection
1CH	MIC detection threshold DATA0	R/W	0x20	MIC threshold value DATA0 [7:0]							



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1DH	MIC detection threshold DATA1	R/W	0xFF	MIC threshold value DATA1 [7:0]		
1EH	I ² C reset	W/C	0x00	Reserved		I ² C reset
1FH	Current source setting	R/W	0x07	Reserved		Current source setting [3:0]
20H	Timing delay between L switch enable and switch on order	R/W	0x00	Delay timing setting [7:0]		

I²C Slave Address

ADDR	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
ADDR = L	1	0	0	0	0	1	0	R/W
ADDR = H	1	0	0	0	0	1	1	R/W

Device ID

Address: 00h

Reset Value: 8'b 1111_0011

Type: Read

Bits	Name	Size	Description
[7:6]	Vendor ID	2	Vendor ID
[5:3]	Version ID	3	Device version ID
[2:0]	Revision ID	3	Revision history ID

OVP Interrupt Mask

Address: 01h

Reset Value: 8'b 0000_0000

Type: Read/Write

Bits	Name	Size	Description
7	Reserved	1	Do not use
6	OVP interrupt mask control	1	OVP interrupt function enable/disable 0: Controlled by [5:0] bit 1: Mask all connector side pins OVP interrupt
5	DP_R OVP interrupt mask control	1	0: Do not mask OVP interrupt 1: Mask OVP interrupt
4	DN_L OVP interrupt mask control	1	0: Do not mask OVP interrupt 1: Mask OVP interrupt
3	SBU1 OVP interrupt mask control	1	0: Do not mask OVP interrupt 1: Mask OVP interrupt
2	SBU2 OVP interrupt mask control	1	0: Do not mask OVP interrupt 1: Mask OVP interrupt
1	GSBU1 OVP interrupt	1	0: Do not mask OVP interrupt

	mask control		1: Mask OVP interrupt
0	GSBU2 OVP interrupt mask control	1	0: Do not mask OVP interrupt 1: Mask OVP interrupt

OVP INTERRUPT Flag

Address: 02h

Reset Value: 8'b 0000_0000

Type: Read Clear

Bits	Name	Size	Description
[7:6]	Reserved	2	Do not use
5	DP_R OVP	1	0: OVP event has not occurred 1: OVP event has occurred
4	DN_L OVP	1	0: OVP event has not occurred 1: OVP event has occurred
[3:2]	SBU1 SBU2 OVP	2	0: OVP event has not occurred 1: At least one of SBU1 or SBU2 OVP event has occurred
1	GSBU1 OVP	1	0: OVP event has not occurred 1: OVP event has occurred
0	GSBU2 OVP	1	0: OVP event has not occurred 1: OVP event has occurred

OVP Status

Address: 03h

Reset Value: 8'b 0000_0000

Type: Read

Bits	Name	Size	Description
[7:6]	Reserved	2	Do not use
5	OVP on DP_R pin	1	0: OVP event has not occurred 1: OVP event has occurred
4	OVP on DN_L pin	1	0: OVP event has not occurred 1: OVP event has occurred
[3:2]	SBU1 SBU2 OVP	2	0: OVP event has not occurred 1: At least one of SBU1 or SBU2 OVP event has occurred
1	OVP on GSBU1 pin	1	0: OVP event has not occurred 1: OVP event has occurred
0	OVP on GSBU2 pin	1	0: OVP event has not occurred 1: OVP event has occurred

Switching Setting Enable

Address: 04h

Reset Value: DIO4481/L: 8'b 1001_1000

DIO4481B/LB: 8'b 1111_1000

Type: Read/Write

Bits	Name	Size	Description
7	Device enable	1	1: Device enable. 0: Device disable; L, R pull down by 10 kΩ and other switch nodes will be high-Z for positive input. Device enable = 1 Device enable = 0 ENN = 1 Device disable Device disable ENN = 0 Device enable Device disable
6	SBU1_H to SBUx switches	1	0: Switch disable; SBU1_H will be high-Z for positive input 1: Switch enable
5	SBU2_H to SBUx switches	1	0: Switch disable; SBU2_H will be high-Z for positive input 1: Switch enable
4	DN_L to DN or L switches	1	0: Switch disable; DN_L, DN will be high-Z for positive input. L pull down by 10 kΩ 1: Switch enable
3	DP_R to DP or R switches	1	0: Switch disable; DP_R, DP will be high-Z for positive input. R pull down by 10 kΩ 1: Switch enable
2	Sense to GSBUX switches	1	0: Switch disable; Sense, GSBU1 and GSBU2 will be high-Z for positive input 1: Switch enable
1	MIC to SBUx switches	1	0: Switch disable; MIC will be high-Z for positive input. 1: Switch enable
0	AGND to SBUx switches	1	0: Switch disable; AGND will be high-Z for positive input. 1: Switch enable

Switch Select

Address: 05h

Reset Value: 8'b 0001_1000

Type: Read/Write

Bits	Name	Size	Description
7	Reserved	1	Do not use
6	SBU1_H switches	1	0: SBU1_H to SBU1 switch ON 1: SBU1_H to SBU2 switch ON
5	SBU2_H switches	1	0: SBU2_H to SBU2 switch ON 1: SBU2_H to SBU1 switch ON
4	DN_L to DN or L switches	1	0: DN_L to L switch ON 1: DN_L to DN switch ON
3	DP_R to DP or R switches	1	0: DP_R to R switch ON 1: DP_R to DP switch ON

2	Sense to GSBUX switches	1	0: Sense to GSBU1 switch ON 1: Sense to GSBU2 switch ON
1	MIC to SBUx switches	1	0: MIC to SBU2 switch ON 1: MIC to SBU1 switch ON
0	AGND to SBUx switches	1	0: AGND to SBU1 switch ON 1: AGND to SBU2 switch ON

Switch Status0

Address: 06h

Reset Value: 8'b 0000_0101

Type: Read Only

Bits	Name	Size	Description
[7:6]	Reserved	2	Do not use
[5:4]	Sense switch status	2	00: Sense switch is open/not connected 01: Sense connected to GSBU1 10: Sense connected to GSBU2 11: Not valid
[3:2]	DP_R switch status	2	00: DP_R switch open/Not connected 01: DP_R connected to DP 10: DP_R connected to R 11: Not valid
[1:0]	DN_L switch status	2	00: DN_L switch open/not connected 01: DN_L connected to DN 10: DN_L connected to L 11: Not valid

Switch Status1

Address: 07h

Reset Value: DIO4481/L: 8'b 0000_0000

DIO4481B/LB: 8'b 0010_0011

Type: Read Only

Bits	Name	Size	Description
[7:6]	Reserved	2	Do not use
[5:3]	SBU2 switch status	3	000: SBU2 switch is open/not connected 001: SBU2 connected to MIC 010: SBU2 connected to AGND 011: SBU2 connected to SBU1_H 100: SBU2 connected to SBU2_H 101: SBU2 connected both SBU1_H and SBU2_H 110...111: Do not use
[2:0]	SBU1 switch status	3	000: SBU1 switch is open/not connected 001: SBU1 connected to MIC 010: SBU1 connected to AGND 011: SBU1 connected to SBU1_H 100: SBU1 connected to SBU2_H



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			101: SBU1 connected both SBU1_H and SBU2_H 110...111: Do not use
--	--	--	---

Audio Switch Left Channel Slow Turn-on

Address: 08h

Reset Value: 8'b 0000_0001

Type: Read/Write

Bits	Name	Size	Description
[7:0]	Switch turn on rising time setting	8	11111111: 25600 μ s
			...
			00000001: 200 μ s
			00000000: 100 μ s

Audio Switch Right Channel Slow Turn-on

Address: 09h

Reset Value: 8'b 0000_0001

Type: Read/Write

Bits	Name	Size	Description
[7:0]	Switch turn on rising time setting	8	11111111: 25600 μ s
			...
			00000001: 200 μ s
			00000000: 100 μ s

MIC Switch Slow Turn-on

Address: 0Ah

Reset Value: 8'b 0000_0001

Type: Read/Write

Bits	Name	Size	Description
[7:0]	Switch turn on rising time setting	8	11111111: 25700 μ s
			...
			00000010: 350 μ s
			00000001: 250 μ s
			00000000: Not valid

Sense Switch Slow Turn-on

Address: 0Bh

Reset Value: 8'b 0000_0001

Type: Read/Write

Bits	Name	Size	Description
[7:0]	Switch turn on rising time setting	8	11111111: 25600 μ s
			...



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			00000001: 200 μ s
			00000000: 100 μ s

Audio Ground Switch Slow Turn-on

Address: 0Ch

Reset Value: 8'b 0000_0001

Type: Read/Write

Bits	Name	Size	Description
[7:0]	Switch turn on rising time setting	8	11111111: 179000 μ s
			...
			00000001: 1400 μ s
			00000000: 700 μ s

Timing Delay between R Switch Enable and Switch on Order

Address: 0Dh

Reset Value: 8'b 0000_0000

Type: Read/Write

Bits	Name	Size	Description
[7:0]	Delay timing setting	8	11111111: 102 ms
			11111110: 101.6 ms
			...
			00000001: 400 μ s
			00000000: 0 μ s

Timing Delay between MIC Switch Enable and Switch on Order

Address: 0Eh

Reset Value: 8'b 0000_0000

Type: Read/Write

Bits	Name	Size	Description
[7:0]	Delay timing setting	8	11111111: 102 ms
			11111110: 101.6 μ s
			...
			00000001: 400 μ s
			00000000: 0 μ s



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Timing Delay between Sense Switch Enable and Switch on Order

Address: 0Fh

Reset Value: 8'b 0000_0000

Type: Read/Write

Bits	Name	Size	Description
[7:0]	Delay timing setting	8	11111111: 102 ms
			11111110: 101.6 ms
			...
			00000001: 400 μ s
			00000000: 0 μ s

Timing Delay between Audio Ground Switch Enable and Switch on Order

Address: 10h

Reset Value: 8'b 0000_0000

Type: Read/Write

Bits	Name	Size	Description
[7:0]	Delay timing setting	8	11111111: 102 ms
			11111110: 101.6 ms
			...
			00000001: 400 μ s
			00000000: 0 μ s

Audio Accessory Status

Address: 11h

Reset Value: 8'b 0000_0010

Type: Read/Write

Bits	Name	Size	Description
[7:2]	Reserved	6	Do not use
1	CC_IN	1	0: CC_IN < 1.2 V 1: CC_IN > 1.5 V
0	DET	1	0: DET output is low 1: DET output is high

Function Enable

Address: 12h

Reset Value: 8'b 0000_0000

Type: Read/Write

Bits	Name	Size	Description
7	Reserved	1	Do not use
6	DET I/O control	1	1: DET pin is in open/drain configuration 0: DET pin is in push/pull configuration

5	Reserved	1	Do not use
4	GPIO control enable	1	Do not use
3	Slow turn on control enable	1	1: Enable 0: Disable
2	MIC auto break out control enable	1	1: Enable 0: Disable
1	Reserved	1	Do not use
0	Audio jack detection and configuration enable	1	1: Enable; will be changed to '0' after audio jack detection and configuration 0: Disable

When GPIO control mode (manual switch control) is enabled, 'Switch control' register is changed to read only.

RES Detection Pin Setting

Address: 13h

Reset Value: 8'b 0000_0000

Type: Read/Write

Bits	Name	Size	Description
[7:3]	Reserved	5	Do not use
[2:0]	Resistance detection pin select	3	000: CC_IN 001: DP_R 010: DN_L 011: SBU1 100: SBU2 101: Do not use ... 111: Do not use

Recommend user to select the pin first before setting the RES detection pin enabled.

Moisture Occur Pin Indicate

Address: 14h

Reset Value: 8'b 0000_0000

Type: Read

Bits	Name	Size	Description
[7:6]	Reserved	3	Do not use
[5:0]	Moisture occur pin indicate	5	High to low corresponds to: <5>:MOIS_CCIN_OCCUR = 0, when 13h = 000 and A2D_MOISTURE_OCCUR = 1, otherwise =1; <4>:MOIS_DPR_OCCUR = 0, when 13h = 001 and A2D_MOISTURE_OCCUR = 1, otherwise = 1; <3>:MOIS_DNL_OCCUR = 0, when 13h = 010 and A2D_MOISTURE_OCCUR = 1, otherwise =1; <2>:MOIS_SBU1_OCCUR = 0, when 13h = 011 and A2D_MOISTURE_OCCUR = 1, otherwise = 1; <1>:MOIS_SBU2_OCCUR = 0, when 13h = 100 and A2D_MOISTURE_OCCUR = 1, otherwise = 1;



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<0>:MOIS_SBU2 or SBU1_OCCUR = 0, when 13h = 101 and A2D_MOISTURE_OCCUR = 1, otherwise = 1;

RES Detection Threshold

Address: 15h

Reset Value: 8'b 0000_0010

Type: Read/Write

Bits	Name	Size	Description
[7:3]	Reserved	5	Do not use
[2:0]	Resistance detection threshold configuration	3	Resistance detection threshold configuration

RES Detection Interval

Address: 16h

Reset Value: 8'b 0000_0100

Type: Read/Write

Bits	Name	Size	Description
[7:4]	Reserved	4	Do not use
[3:2]	RES detection duration time	2	00: Reserved 01: 5 ms 10: 10 ms 11: 20 ms
[1:0]	RES detection interval	2	00: Single 01: 100 ms 10: 1 s 11: 10 s

Audio Jack Status

Address: 17h

Reset Value: 8'b 0000_0001

Type: Read

Bits	Name	Size	Description
[7:4]	Reserved	4	Do not use
3	4 pole	1	1: 4 pole SBU2 to MIC, SBU1 to audio ground 0: others
2	4 pole	1	1: 4 pole SBU1 to MIC, SBU2 to audio ground 0: Others
1	3 pole	1	1: 3 pole 0: Others
0	No audio accessory	1	1: No audio accessory 0: Reserved



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RES Detection/Audio Jack Detection Interrupt Flag

Address: 18h

Reset Value: 8'b 0000_0000

Type: Read Clear

Bits	Name	Size	Description
[7:3]	Reserved	5	Do not use
2	Audio jack detection and configuration	1	0: Audio jack detection and configuration has not occurred 1: Audio jack detection and configuration has occurred
1	Low resistance occurred	1	0: Low resistance has not occurred 1: Low resistance has occurred
0	Low resistance detection	1	0: Low resistance has not occurred 1: Low resistance has occurred

RES/Audio Jack Detection Interrupt Mask

Address: 19h

Reset Value: 8'b 0000_0000

Type: Read/Write

Bits	Name	Size	Description
[7:3]	Reserved	5	Do not use
2	Audio jack detection and configuration	1	1: Mask audio jack detection and configuration has occurred interrupt
1	Low resistance occurred	1	1: Low resistance has occurred interrupt
0	Low resistance detection	1	1: Low resistance detection has occurred interrupt

MIC Detection Threshold Data0

Address: 1Ch

Reset Value: 8'b 0010_0000

Type: Read/Write

Bits	Name	Size	Description
[7:0]	MIC detection threshold DATA0	8	MIC detection threshold DATA0 0010_0000: 300 mV

MIC Detection Threshold Data1

Address: 1Dh

Reset Value: 8'b 1111_1111

Type: Read/Write

Bits	Name	Size	Description
[7:0]	MIC detection threshold DATA1	8	MIC detection threshold DATA1 1111_1111: 2.4 V



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USB Type-C Analog Audio Switch with Protection Function

I²C Reset

Address: 1Eh

Reset Value: 8'b 0000_0000

Type: W/C

Bits	Name	Size	Description
[7:1]	Reserved	7	Reserved
0	I ² C reset	1	0: default 1: I ² C reset

Current Source Setting

Address: 1Fh

Reset Value: 8'b 0000_0111

Type: Read/Write

Bits	Name	Size	Description
[7:4]	Reserved	4	Reserved
[3:0]	Current source setting	4	1111: 1500 μ A 0111: 700 μ A 0001: 100 μ A 0000: invalid

Timing Delay between L Swtich Enable and Switch on Order

Address: 20h

Reset Value: 8'b 0000_0000

Type: Read/Write

Bits	Name	Size	Description
[7:0]	Delay timing setting	8	11111111:102 ms
			11111110:101.6 ms
			...
			00000001:400 μ s
			00000000:0 μ s

Application Information

Over-Voltage Protection

The DIO4481/B/L/LB features over-voltage protection (OVP) on receptacle side pins that turns off the internal signal routing path if the voltage exceeds the OVP threshold. If the OVP occurs, the open-drain output pin INT will be pulled down. Flag register 0×02h and 0×03h will indicate which pin had an OVP event.

Headset Detection

The DIO4481/B/L/LB integrates the headset unplug detection function by detecting the CC_IN voltage. The function will be active when the device is enabled. Output pin DET will be high when CC_IN is low (CC_IN < 1.2 V), and DET will be low when CC_IN = High (CC_IN > 1.5 V).

	Device Disable	Device Enable
CC_IN < 1.2 V	DET = 0	DET = 1
CC_IN > 1.5 V	DET = 0	DET = 0

MIC Switch Auto-off Function

The function is active during control bit 0×12 h bit [2] = 1. When CC_IN is changed from low to high, and L, R, AGND switches are under on status, the MIC switch will be off and the receptacle side pin will be pulled to the ground for 50 μs first. Then it shows that the high-Z status under the MIC switch is set on status.

Audio Jack Detection and Configuration

The function is active when control bit 0×12h bit [0] = 1. When the headset is inserted, the DIO4481/B/L/LB can detect OMTP, CTIA, or 3-pole headsets and configure pinout automatically. During detection and configuration, the R, L, Sense, MIC, and Audio ground switches will be off. After detection and configuration, R, L, MIC, Sense, and AGND switches will turn on according to detection results and timing control settings.

Moisture Detection

The function is active during control bit 0×12h bit[1] = 1. It will monitor the resistance between receptacle side pins and the ground. The resistance detection pin can be selected by register 0×13h. During moisture detection, the switch, which is monitored, will be off. The detection result will be saved in the resistance flag register 0×14h. The measurement threshold could be from 200 kΩ to 1 MΩ, which is configured by the internal register. The detection interval can be set at single, 100 ms, 1 s, or 10 s by registering 0×16h.

Manual Switch Control

The function is active during control bit $0 \times 12h$ bit [4] = 1 and $0 \times 04h = FF$. It will provide manual control for the device. During this configuration, ADDR and INT pins will be set as the logic control input.

Power	ENN	ADDR	INT	SENSE Switch	Headset Detection	USB Switch	Audio Switch	MIC/Audio GND Switch	SBU by Pass Switch
OFF	X	X	X	OFF	OFF	OFF	OFF	OFF	OFF
ON	H	X	X	OFF	OFF	OFF	OFF	OFF	OFF
ON	L	0	0	OFF	OFF	ON: DP_R to DP DN_L to DN	OFF	OFF	ON: SBU1 to SBU1_H SBU2 to SBU2_H
ON	L	0	1	OFF	OFF	ON: DP_R to DP DN_L to DN	OFF	OFF	ON: SBU1 to SBU2_H SBU2 to SBU1_H
ON	L	1	0	ON GSBU2 to SESNE	ON	OFF	ON: DP_R to R DN_L to L	ON: SBU1 to MIC SBU2 to AGND	OFF
ON	L	1	1	ON GSBU1 to SESNE	ON	OFF	ON: DP_R to R DN_L to L	ON: SBU2 to MIC SBU1 to AGND	OFF

I²C Interface

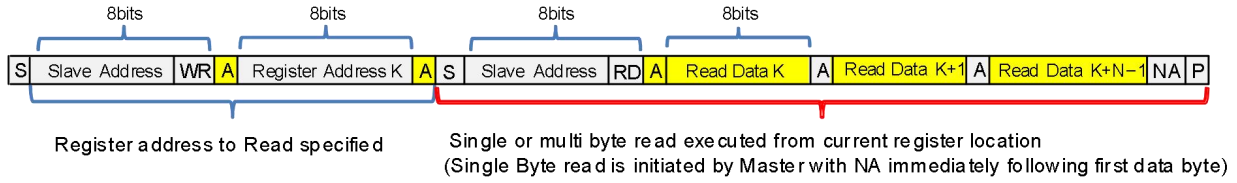
The DIO4481/B/L/LB includes a full I²C slave controller. The I²C slave fully complies with the I²C specification version 2.1 requirements. This block is designed for fast mode, 400 kHz, signals. Examples of an I²C write and read sequence are shown in the below figures respectively.



Note:

- (1) Single-byte read is initiated by the master with P immediately following the first data byte.

Figure 3. I²C write example



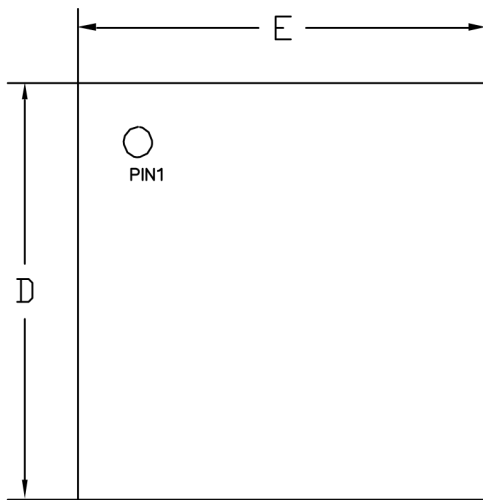
Note:

(1) If the register is not specified, the master will begin reading from the current register. In this case, only sequence showing in the red bracket is needed.

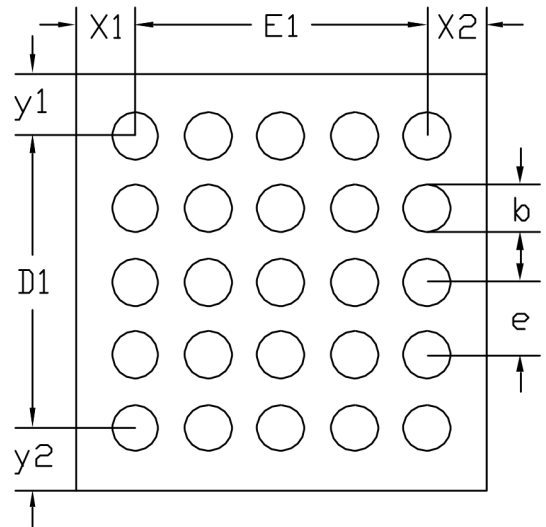
	From Master to Slave	S	Start Condition	NA	NOT Acknowledge (SDA High)	RD	Read =1
	From Slave to Master	A	Acknowledge (SDA Low)	WR	Write = 0	P	Stop Condition

Figure 4. I²C read example

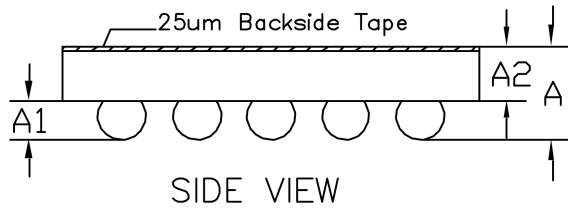
Physical Dimensions: WLCSP-25



TOP VIEW
(MARK SIDE)



BOTTOM VIEW
(BALL SIDE)



SIDE VIEW

Common Dimensions (Units of measure = Millimeter)			
Symbol	Min	Nom	Max
A	0.547	0.586	0.625
A1	0.190	0.210	0.230
A2	0.351	0.376	0.401
D	2.250	2.280	2.310
D1	1.600 BSC		
E	2.210	2.240	2.270
E1	1.600 BSC		
b	0.238	0.258	0.278
e	0.400 BSC		
x1	0.320 REF		
x2	0.320 REF		
y1	0.340 REF		
y2	0.340 REF		



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CONTACT US

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For additional product information or full datasheet, please contact our sales department or representatives.